Annealing study of the electron-irradiation-induced defects H_4 and E_{11} in InP: Defect transformation $(H_4-E_{11}) \rightarrow H'_4$

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Capacitance spectroscopy has been used to study the two dominant deep levels, H_4 and E_{11} , produced in InP by low-energy electron irradiation. The annealing rates of H_4 and E_{11} in the *p*-type material are found to be identical, as is also the dependence on free-carrier recombination and on the chemical nature of the acceptor (Cd or Zn). Recombination-enhanced annealing converts these traps to a hole trap H'_4 , which is not detectable by conventional deep-level transient spectroscopy. Its emission and capture properties are measured and analyzed. The similarity of the creation and annealing behavior of H_4 and E_{11} shows that they share a common point defect. Our results lead to the tentative identification of the defect as a phosphorous vacancy-acceptor complex and we show how this may anneal to the H'_4 center.

I. INTRODUCTION

Even though the study of electron-irradiation-induced defects (EIID's) in InP is far less extensive than in GaAs, the corresponding hole and electron traps were classified a few years ago. An initial picture of defect formation and defect reactions has begun to emerge, $^{1-12}$ but it needs to be clarified and confirmed by complementary experimental work.

The experiments described in the present paper were conducted with the aim of testing the hypothesis that the two main EIID's, the hole trap H_4 in *p*-type InP and the electron trap E_{11} in *n*-type InP, result from strongly correlated microscopic defects having some common point defect. This hypothesis was raised by Sibille and co-workers,¹ who first demonstrated that H_4 and E_{11} are both generated by the primary electron collision in the phosphorus sublattice² and also observed that their above room-temperature (**R**T) annealing kinetics are identical,³ whether measured in the hole or electron-free state and in *p*- or *n*-type material.

To allow a more direct and more reliable comparison we studied the annealing of H_4 and E_{11} at the same time in a single *p*-type sample in which the minority-carrier trap E_{11} was expected to exist. The annealing out of the majority-carrier trap H_4 is observed by deep-level transient spectroscopy (DLTS), while optical filling and thermal emptying (ODLTS) are used for the minoritycarrier trap E_{11} .

The results confirm the strong correlation of these two dominant EIID's and also reveal that, in the case of Zn doping, the simultaneous annealing of H_4 and E_{11} generates another hole trap that has already been briefly described in a previous communication⁴ and labeled H'_4 . This hole level H'_4 , generated by a local-defect transformation, has very specific weak-hole-capture properties which make it undetectable in the usual DLTS experiment.

The defect transformation $(H_4 - E_{11}) \rightarrow H'_4$ is strongly enchanced by the recombination of free carriers,

recombination-enhanced defect reaction (REDR) mechanism, with an approximate 0.3 output efficiency. This excludes a long-range diffusion process followed by retrapping on randomly distributed defects or impurities. The identity of the behavior of the annealing kinetics of H_4 and E_{11} is observed here as well as in pure thermal treatments as under stimulation by electron injection. This is a strong indication that these two electronic levels correspond to the same microscopic [D(P)-acceptor] complex which is tentatively identified as a $(V_P - A^-)$ pair.

The paper is organized as follows. In Sec. II we review briefly the literature on the creation, the annealing properties, and the physical characteristics of the two dominant EIID's in InP, H_4 and E_{11} . Experimental details are briefly exposed in Sec. III. Section IV concerns the simultaneous annealing of (H_4-E_{11}) in Zn- and Cd-doped *p*-type InP. The physical characteristics of the thermally generated hole trap H'_4 are described in Sec. V and phenomenologically explained with the help of a onedimensional configuration-coordinate diagram (CCD). The local-defect transformation $(H_4-E_{11})\rightarrow H'_4$ is discussed in Sec. VI and a responsible microscopic defect is tentatively identified. The main results and conclusions are summarized in Sec. VII.

II. REVIEW OF THE EIID'S H_4 AND E_{11} IN InP

The generation and annealing properties of the hole trap H_4 in p-type InP ($E_a = 0.37$ eV, $\sigma_a = 8.10^{-16}$ cm²) have been extensively studied in France by the CNET group,¹⁻⁷ and in Japan by the NTT group.⁷⁻¹⁰ It was first demonstrated by Sibille and co-workers that H_4 is produced by the selective displacement of the P_{31} host atom during the initial incoming electron collision and not by the displacement of the heavier In₁₁₅ atom. This was done by comparing the differential threshold energies of the production rates of many EIID's and also by comparing the creation efficiencies along the (111) and the ($\overline{111}$) crystallographic directions which favor either the P or the In ejection to the interstitial site.²

At the same time it was soon realized by these authors⁵ that H_4 is not a simple intrinsic defect but a complex involving the p-type doping impurity. The experimental demonstration of the complex character of the H_4 defect is rather indirect since its physical properties, thermal and optical hole emission rates, do not depend on the acceptor species, Zn or Cd, and since the RT stable concentration $[H_4]$ attained for a given fluence is not clearly related to the doping level. Actually its complex nature was inferred from the occurrence of secondary defect reactions following 25-K electron irradiation and from small differences between the annealing kinetics in Znand Cd-doped crystals.⁶ Heating at 300 K after lowtemperature (LT) irradiation results in a noticeable increase of H_4 concentration which is thus created by thermally activated secondary reactions (stage I). It has also been observed⁶ that the above RT annealing of H_4 in a purely thermal process (stage II) and of three other deep levels, labeled H_2 , H_3 , and E_{11} , are identical and exactly first order with Cd doping and not quite first order with Zn doping, with an effective frequency,

$$\frac{1}{[D]} \frac{d[D]}{dt} = K(T) = 2 \times 10^{15} \exp \left[-\frac{1.32 \text{ eV}}{kT}\right]$$

The high value of the pre-exponential factor shows that the annealing rates are dominated by a local reaction and the common 1.32-eV value of the activation energy that the atomic event concerned is the same for the whole group of defects. To account for the stage-I reactions following low-temperature irradiation and the stage-II annealing out, they proposed that the defects are $[D(P) - A^{-}]$ complexes, where D(P) is either V_P or P_i . However, the local character of the dominant annealing process is questioned by the work of Yamaguchi and Ando,⁷ who observed strong doping impurity effects on the creation efficiency and on the annealing rates of H_4 and H_5 in Zn-doped *p*-type InP irradiated with 1-MeV electrons or γ rays.^{8–10} For these authors, H_4 has first-order annealing kinetics in the Zn-doped material but with an effective frequency K proportional to the $\frac{2}{3}$ power of the Zn doping level. They assign this sensitivity to the Zn content to a simultaneous generation of H_5 by association of a released constituent of H_4 to the acceptor. However, the identification of the γ -ray-induced levels with H_4 and H_5 seems questionable and the reason for this apparent correlation between the annealing of H_4 and the increase of H_5 is far from clear, since it has been established that H_5 is a complex defect originating in the In sublattice,¹¹ while H_4 originates in the P sublattice. Obviously additional experiments are desirable.

The electron trap E_{11} ($E_a = 0.72 \text{ eV}$, $\sigma_a = 2.10^{-13} \text{ cm}^2$) has until now only been observed by capacitance technique in *n*-type material with p^+ -*n* junctions but not in devices with Schottky barriers.^{12,13}

From this Benton *et al.*¹² first speculated that E_{11} (E_{10} in their paper) is a complex defect resulting from an interaction between a primitive irradiation damage and another defect introduced during the p^+ -n junction preparation procedure.

Later it was demonstrated¹³ that the primitive radiation damage occurs on the P sublattice and that E_{11} results from a secondary reaction with the acceptors in the p^+ region. This was shown by the strong spatial dependence of the frequency of its first-order annealing kinetics,

$$K_{(T)} = -\frac{1}{[E_{11}]} \frac{d[E_{11}]}{dt}$$

in the p^+ -n junction. This frequency decreases towards the p^+ side where the dissociation of the complex defect responsible for E_{11} , $[D(P)-S_{11}]$, is more efficiently counterbalanced by the recapture event $D(P)+S_{11}\rightarrow E_{11}$.

To close this review it is worth noting that (1) the annealing of H_4 and E_{11} is charge-state dependent (see Table I), and exactly identical in their respective hole and electron empty states, and (2) the annealing of both H_4 and E_{11} is stimulated by minority-carrier injection (electron injection for H_4 and hole injection for E_{11}), and a detailed analysis of this recombination-enhanced defect reaction has been given.¹⁴

III. EXPERIMENTAL DETAILS

Some of the samples used in this work were evaporated Ti-Au Schottky barriers on *p*-type InP [Czochralski Zn-doped or Cd-doped liquid-phase-epitaxy (LPE) layers]. Most samples, however, were LPE Zn-doped p^+ -*p*- n^+ junctions with $p \sim 1 \times 10^{16}$ cm⁻³. RT irradiation, with incident-electron energies ranging from 300 keV to 1 MeV, were performed on a Van de Graff accelerator at low current densities (1 μ A cm⁻²) and electron doses ranging from 10¹³ to 10¹⁶ e cm⁻².

The ODLTS and DLOS data were obtained with the double-grating monochromator system described previously.¹⁵ The incident photon energy uncertainty is approximately 20 meV.

Direct-capture cross-section measurements of H'_4 were made by partial refilling. The available range of temperature was increased towards the LT side by using optical emptying below 150 K. The unusually large values of the capture time τ_c , greater than 100 s at 120 K, required a specific experimental protocol and its exponential increase with decreasing temperature restricted the available domain to T > 110 K.

IV. ANNEALING OF H_4 AND E_{11} IN *p*-TYPE InP

A. Trap identification

Typical DLTS and ODLTS spectra of an n^+ -p, Zndoped InP junction, irradiated at 1 MeV at RT, are shown in Fig. 1. The majority-carrier traps H_4 and H_5 are those usually observed in the p-type material while the ODLTS reveals two minority-carrier traps. The shallower one, labeled EP_1 and occurring near 120 K, is not an EIID since it is also observed in unirradiated samples. The deeper one, EP_2 around ~270 K, is only observed in irradiated samples and is identified with the level E_{11} in *n*-type InP by the near identity of their electron emission rates. The ODLTS signature of EP_2 in the *p*-type material is

$$E_a = 0.70 \text{ eV}, \sigma_a = 1.10^{-13} \text{ cm}^2,$$

while the averaged published data on E_{11} obtained by DLTS in *n*-type samples is

$$E_a = 0.72 \text{ eV}, \sigma_a = 2.10^{-13} \text{ cm}^2$$

This identification of EP_2 with E_{11} is fully buttressed by the identity of their creation properties shown in Fig. 2. It is thus clearly established for the first time that the level E_{11} , which acts as an electron trap in *n*-type InP, is also generated in *p*-type material by electron irradiation.

By changing the forward pulse duration in the DLTS experiments from 0.5 ms to 4 s, one observes in Fig. 3(a) a slight increase of the peak attributed to H_4 and a concomitant shift towards higher temperatures. This reveals that there exists an unresolved hole trap, with a smaller



FIG. 1. (a) DLTS spectrum of an n^+ -p InP irradiated junction. The hole traps are labeled in agreement with Refs. 3 and 5. (b) Direct comparison of the electron emission rates of the minority carrier trap EP_2 , observed by ODLTS in an n^+ -p junction, and of the level E_{11} observed by DLTS in a p^+ -n junction. N is either the acceptor concentration N_a or the donor concentration N_d .



FIG. 2. Introduction rates of the level E_{11} in the *n*-type material and of the levels H_4 and EP_2 in the *p*-type material, as a function of the incoming electron energy. The data for H_4 and E_{11} include ours and those of Ref. 2. The dashed line corresponds to the H_4 level and is extracted from Ref. 2.

concentration than H_4 and a nearly identical hole emission time, but with a much weaker hole-capture cross section. This level, labeled H'_4 , is fully resolved after heating the sample during 75 h at 110 °C [see Fig. 3(b)], which totally erases the signal due to the faster capturing level H_4 .



FIG. 3. (a) Amplitude variation and temperature shift of the DLTS peak attributed to H_4 when the filling pulse duration is changed from 0.5 ms to 4 s (solid line). (b) After subsequent annealing the contribution of H_4 , dashed line, has vanished and H'_4 is totally resolved.

B. Annealing of H_4 and E_{11}

The hole level H'_4 is generated by secondary reactions of the EIID's since it is not detected in unirradiated samples giving the same thermal treatment. Additionally, the thermal generation of H'_4 is only observed in the Zndoped Schottky or n^+ -p junctions, but not in the Cd Schottky junctions.

Since it has been previously established that the annealing kinetics of H_4 are exactly first order in Cd-doped InP, but not in Zn-doped InP, this sensitivity of the generation of H'_4 to the acceptor species is a good indication that the increase of $[H'_4]$ is related to the disappearance of H_4 .

The strong correlation between the thermal generation of H'_4 and the annealing out of (H_4-E_{11}) is clearly demonstrated by the simultaneous study of their concentration changes in the same sample. To do so, the annealing procedure was accelerated by a minority-carrier injection, i.e., electron injection in the n^+ -p junctions used. The relative contributions of H_4 and H'_4 to the DLTS spectra



FIG. 4. (a) Comparison, during annealing, of the concentrations of the levels E_{11} (ODLTS) and H_4 (DLTS). Both concentrations are normalized to their initial value. (b) Comparison, during annealing, of the normalized concentrations of the vanishing levels H_4 or E_{11} and of that of the growing defect H'_4 . In these experiments, the annealing process is enhanced by electron injection under saturated conditions, $J = 6 \text{ A cm}^{-2}$. The final efficiency of the defect transformation $(H_4 - E_{11}) \rightarrow H'_4$ is 0.2 to ~0.3.

are easily separated by changing the filling pulse duration, and the changes in the respective concentrations of H'_4 , H_4 , and E_{11} were also measured by thermostimulated-capacitance scans.

The results are collected together in Fig. 4. They show, that in Zn-doped InP the following is true.

The annealing kinetics of H_4 and E_{11} are identical.

The annealing of the hole level H_4 and also of the electron trap E_{11} are enhanced in the same way by the electron injection and occur below RT.

The growth kinetics of H'_4 reflects exactly the joint disappearance of $(H_4 - E_{11})$.

The defect transformation $(H_4-E_{11})\rightarrow H'_4$ is an 0.2 to 0.3 transformation (see Fig. 5), but an exact balance is difficult since in the case of H_4 and H'_4 the DLTS peak amplitude depends on the level depth and because optical filling is used for E_{11} .

Even though the recombination-enhanced annealing kinetics of (H_4-E_{11}) is not first order, we have measured the temperature dependence of the initial slope,

$$K_{(T)} = -\frac{1}{[H_4]} \frac{d[H_4]}{dt} = -\frac{1}{[E_{11}]} \frac{d[E_{11}]}{dt} ,$$

and found that it is well described by

$$K = 3.3 \times 10^3 \exp\left[-\frac{0.22 \text{ eV}}{kT}\right] \,.$$

Comparison of this result with previously published data is made in Table I. These agree, within the experimental uncertainties, with the results of Refs. 3, 5, and 14 on the hole trap H_4 .

In the case of Cd doping (Schottky diodes and thermal treatment) the hole trap H_4 and the minority-carrier trap E_{11} are still observed to have exact first-order annealing kinetics, in perfect agreement with Ref. 3, but the generation of H'_4 is no longer observed.



FIG. 5. Defect concentration profiles, obtained by differential deep-level transient spectroscopy, of the initial EIID H_4 before annealing, and of the generated level H'_4 .

TABLE I. Values of the activation energy, E, and of the pre-exponential factor, v, of the annealing rates: $K = v \exp(-E/kT)$, of the electron-irradiation-induced defects H_4 and E_{11} . When the process is not first order, under minority-carriers injection, for instance, the values are taken at the beginning of the annealing.

Level H_4		Empty of holes	Filled with holes	With additional electron injection	Refs.
p-type InP	E (eV) v (s ⁻¹)	1.32 2×10 ¹⁵	1.69 2×10 ¹⁸	0.24 2.8×10 ⁴	3,5,14
	$\frac{E}{v} (eV)$ v (s ⁻¹)		1.02 2.72 $(p)^{2/3}$	0.133 19.35 <i>J</i>	7,8
	$\frac{E}{v} (eV)$ $v (s^{-1})$		1.69 2×10 ¹⁸	0.22 3.3×10^{3}	this work
n-type InP	E (eV) ν (s ⁻¹)	0.68 1.5×10 ¹⁵			7
Level E_{11}		Empty of electrons	Filled with electrons	With additional hole injection	Refs.
n-type InP	E (eV) v (s ⁻¹)	1.32 2×10 ¹⁵	1.27 3×10 ¹⁵		3,5,14
	$\frac{E}{v} (eV)$ $v (s^{-1})$	1.30 1×10 ¹⁵	1.30 2×10^{16}	0.42 10 ³	12
				With additional electron injection	
p-type InP	E (eV) v (s ⁻¹)			0.22 3.3×10 ³	this work

V. PHYSICAL PROPERTIES OF THE HOLE TRAP H'_4

The hole emission rates of H_4 and H'_4 are shown for comparison in Fig. 6. Their hole emission times differ by a factor of about 2 to 5. Least-squares analysis of these data gives rather different signatures:

	E_a (eV)	$\sigma_a \ (\text{cm}^2)$
H_{4}	0.37	8×10^{-16}
H'_4	0.50	4×10^{-12}

The drastic difference between H_4 and H'_4 lies in their hole-capture properties. Actually, we could not proceed to direct measurements of the hole-capture cross section of H_4 since its capturing time $\tau_c = (p\sigma v)^{-1}$, estimated from $p \sim 10^{16}$ cm⁻³, $v \sim 10^7$ cm s⁻¹, and $\sigma \sim 10^{-15}$ cm², is in the 10-ns range. By contrast the filling efficiency measurements of H'_4 are made difficult by its very long filling time τ_c which is in the ms range at 190 K but increases exponentially to more than 100 s near 120 K. The hole emission time τ_e , being greater than 10 s at T < 160 K optical emptying, was used below this limit to increase the temperature range to 110 K.

Data for the hole-capture cross section of H'_4 are shown in Fig. 7. It is thermally activated and well described by

$$\sigma_{(T)}(\mathrm{cm}^2) = 10^{-13} \exp\left[-\frac{0.27 \text{ eV}}{kT}\right],$$



FIG. 6. Direct comparison of the hole emission rates of H_4 ($E_a = 0.37 \text{ eV}$, $\sigma_a = 8 \times 10^{-16} \text{ cm}^{-2}$) and of H'_4 ($E_a = 0.50 \text{ eV}$, $\sigma_a = 4 \times 10^{-12} \text{ cm}^{-2}$). Constant values of the emission time τ are shown to allow an easier comparison with other results.



FIG. 7. Direct measurements of the hole-capture cross section of H'_4 in various samples. Samples 1 and 2, Schottky diodes on p type with $p \approx 3 \times 10^{16}$ cm⁻³; samples 2 and 3, p^+ -p-n⁺ diodes with $p \approx 6 \times 10^{16}$ cm⁻³. Below 160 K optical emptying is used in place of thermal emptying. The capturing time τ_c is larger than 100 s at 120 K. The inset shows that the hole filling is perfectly exponential $a(t) = a_{\infty} [1 - \exp(-t/\tau_c)]$.

as expected in a multiphonon-emission process (MPE) when $kT > \hbar\omega$. Such a MPE process implies a saturation of σ_c at low temperatures, when $kT < \hbar\omega$, which was not actually observed. The $T \rightarrow \infty$ extrapolated value of σ_c , 10^{-13} cm², is comparable to that obtained from DLTS, $\sigma_a = 4 \times 10^{-12}$ cm², indicating a small entropy change during the hole trapping.

The optically induced valence-band (VB) $\rightarrow H'_4$ electron transition was observed and the spectral dependence of the corresponding photoionization cross section σ_p^o was measured and analyzed with the help of a previously described experimental setup and fitting procedure.¹⁶ The results are shown in Fig 8.

The experimental onset is at hv=0.6 eV; the solid curve corresponds to the least-squares fit to an analytical expression of the type used by Chantre, Vincent, and Bois¹⁷ with the usual approximations of an equivalent parabolic band, a constant dipole matrix element, and an assumed $1/r \exp(-\alpha r)$ isotropic bound state.

As in the case of the initial EIID H_4 , the complementary $H'_4 \rightarrow$ conduction-band (CB) transition could not be optically induced and all our attempts with various wave-



FIG. 8. Spectral dependence of the normalized photoionization cross section σ_p^o of H'_4 . The solid line corresponds to the analytical expression of Ref. 17 with an optical threshold $E_p^o=0.95\pm0.2$ eV and an assumed $(1/r)\exp(-\alpha r)$ bonded state with $\alpha^{-1}=0.25$ Å.



FIG. 9. Configuration-coordinate diagram of H'_4 which accounts for the weak values and the thermal activation of its hole-capture cross section. The curvature of the infinite set of parabolas in the free-hole state has been slightly reduced to adjust the optical threshold to $0.95\pm0.2 \text{ eV}$. The optical transition of the bonded electron in the $H'_4 + h_{\rm VB}$ state to the conduction band requires hv > Eg.

length and illumination conditions were unsuccessful.

These very weak cross sections and the thermal activation of the hole-capture cross section of H'_4 , as well as the impossibility of inducing the $H'_4 \rightarrow CB$ electron transition by optical excitation, are well explained in a phenomenological way with the help of the one-dimensional configuration-coordinate diagram (CCD) shown in Fig. 9 which displays the very large lattice relaxation following the hole delocalization.

However, the values of $E_a = 0.50$ eV and $E_b = 0.27$ eV corresponding to an equilibrium depth $E_t = 0.23$ eV cannot be exactly reconciled with $E_p^0 \sim 0.95 \pm 0.2$ eV. Consequently, the curvature of the infinite set of parabolas in the free-hole state has been slightly reduced without altering the qualitative validity of the model.

VI. DISCUSSION

As discussed in Sec. I, the common character of the RT annealing of the hole trap H_4 and the electron trap E_{11} was first outlined by Sibille,³ who observed that in a pure thermal process the effective frequency,

$$K = 2 \times 10^{15} \exp \left[-\frac{1.32 \text{ eV}}{kT} \right]$$

is exactly the same in their respective hole and electronfree states when measured, respectively, in *p*- and *n*-type InP.

The high prefactor of the transformation indicates that the moving atomic entity undergoes only one or a few atomic jumps, and the common activation energy (1.3 eV)of the atom that moves is probably the same.

The experiments described in Sec. IV bear out the common annealing of H_4 and E_{11} during a pure thermal process in Zn- and Cd-doped crystals and also under electron injection in the Zn case. This demonstrates that the energy released in the electron-hole recombination enhances exactly in the same manner the annealing of both these two levels. Furthermore, the sensitivity of the annealing kinetics of H_4 to the doping species, Zn or Cd, is confirmed by the present experiments, is also demonstrated for E_{11} , and is clearly related to the occurrence of the quasi-one-for-one transformation $(H_4, E_{11}) \rightarrow H'_4$. These common properties of the $[D(P)-A^-]$ complex at the origin of the electronic levels H_4 and E_{11} can be clearly understood in the following three possible cases.

(a) H_4 and E_{11} correspond to two different and separated complexes which react together in a one-for-one ratio, to generate H'_4 .

(b) H_4 and E_{11} correspond to two different but related complexes and their annealings are governed by the same local jump of their common atomic entity.

(c) H_4 and E_{11} correspond to two different charge states of the same $[D(P)-A^{-}]$ complex.

The hypothesis (a) $H_4 + E_{11} \rightarrow H'_4$, which implies a second-order creation rate, is rejected since the initial concentrations of H_4 and E_{11} , 10^{14} to 10^{15} cm⁻³, are much too low to explain the nearly 0.2 efficiency of the reaction, since it implies a long-range migration and a reassociation of randomly distributed defects.

The hypothesis (b), with H_4 and E_{11} corresponding to two related $[D(P)-A^-]$ complexes, implies that the moving common entity is D(P) since the acceptor is more than likely stable in the In-substituted site. In this hypothesis H_4 and E_{11} can hardly be viewed as corresponding to two different distant $[D(P)-A^-]$ pairs, first and second neighbor for instance, since their concentrations are approximately equal, and, on the other hand, H_4 and E_{11} can scarcely correspond to two different sites of the phosphorus sublattice defect D(P) since the identity of their annealing kinetics is strictly maintained under electron injection which generates local modes of vibration with an efficiency which depends critically on the local symmetry.

For these reasons we propose to explain the full identity of their annealing kinetics by assuming, hypothesis (c), that H_4 and E_{11} correspond to two different charge states of the same [D(P)-acceptor] complex. Assigning to this complex a zero net charge without bonded electrons we propose that H_4 , at $E_v \pm 0.37$ eV, corresponds to the energy change E^{-70} needed for the first ionization,

$$C^0 + e_{\rm VB} \rightarrow C^-$$
,

and that E_{11} , at $E_g - 0.72 = E_v + 0.65$ eV, corresponds to the second ionization step,

 $C^- + e_{\rm VB} \rightarrow C^{2-}$.

With such a simple hypothesis the complex C is in the charge state C^{-} in much of an n^{+} -p junction and in the charge state C^{2-} in a p^{+} -n junction.

In the n^+ -p junction the $C^- \rightarrow C^0$ transition, level H_4 , is induced by the hole accumulation under forward bias and is then followed by the hole re-emission to the VB (DLTS). The $C^- \rightarrow C^{2-}$ transition, level E_{11} , can be induced by optical excitation from the VB and is followed by the thermal re-emission of the seond trapped electron to the CB (DLOS). In a reverse-biased p^+ -n junction and at sufficiently high temperatures the $C^{-} \rightarrow C^{2-}$ transition is induced by forward biasing and the level E_{11} is observed by DLTS, while the $C^- \rightarrow C^0$ transition, corresponding to the level H_4 , is difficult to observe by ODLTS since we have verified on p-type material that the required electron transition from H_4 to the conduction band cannot be optically induced with a high enough efficiency to overcome the simultaneous $VB \rightarrow H_4$ optical transition. It is true, however, that Yamaguchi and Ando (Ref. 10 and references therein) have observed hole traps in the *n*-type material by ODLTS, with activation energies close to that of H_4 , but the identification of one of them with H_4 is questionable, and the exact balance between the optical emptying frequency $\sigma_p^o \phi$ and the total refilling frequency $\sigma_p^o \phi + nSv$ is not the same in a p^+ -n junction and in a n^+ -p one with the $[D(P)-A^-]$ complex located in both cases near the p side.

To go one step further, without being unduly speculative, we propose that the initial phosphorus irradiation damage D(P) of the $[D(P)-A^{-}]$ complex is the phosphorus vacancy V_{P} and that the observed levels (H_{4}, H'_{4}) and E_{11} correspond essentially to its a_{1} and t_{2} levels more or less perturbed by the local reduction of symmetry due to the acceptor pairing or to static Jahn-Teller distortions.

Our first reason is that the position in energy in the forbidden gap of H_4 , H'_4 , and to a lesser extent of (H_2, H_3) , coincides, with an accuracy better than 0.2 eV, with the a_1 level of the unrelaxed phosphorus vacancy calculated in the second-neighbor tight-binding framework by Talwar and Ting¹⁸ for the neutral V^0 state and by Delerue and Lannoo¹⁹ for the three charge states, V^0 , V^+ , and V^{2+} (see Table II). From these it is more than likely that the mobile free vacancies V_P , generated by the electron collision, are positively charged and associate under electrostatic attraction with the ionized acceptors.

The second reason is that these phosphorus vacancies have actually been observed at RT by von Bardeleben using electron paramagnetic resonance²⁰ (EPR) after 1.5-MeV irradiation of Zn-doped InP. The observed $S = \frac{1}{2}$ EPR spectrum was attributed to V^0 , with three bonded electrons, but it can just as well be attributed to V^{2+} with a single electron. This EPR active defect has an introduction rate, 1 cm⁻¹, comparable to those of H_4 and E_{11} . However, a complete identification with H_4 was rejected since it begins to anneal at RT in the highly doped samples ($p > 1.10^{17}$ cm⁻³).

The third reason is that the photoionization crosssection measurements of H_4 and E_{11} have shown that H_4 behaves essentially as an a_1 state of the T_d host crystal, with only one allowed $(\Gamma_8 + \Gamma_7 \rightarrow a_1)$ transition, while E_{11} behaves essentially as a t_2 state with both the VB $\rightarrow E_{11}$ and $E_{11} \rightarrow CB$ allowed transitions. Of course the local symmetry of a $(V_{\rm P} - A^{-})$ pair is reduced at least to C_{3v} by the pair axis, and probably furthermore by local distortions, but the general frame is still valid and the only difference expected is that the $a_1 \rightarrow CB$ dipole transition is not strictly forbidden. In this scheme, E_{11} , with its trapped electron on the t_2 level, would correspond to the perturbated $V_{\rm P}^0$ state, and the electron release by E_{11} would correspond to the $(V_{\rm P}^0 - A^-) \rightarrow (V_{\rm P}^+ - A^-)$ transformation. In the same context H_4 would correspond to the $(V_{\rm P}^{2+} - A^{-}) \rightarrow (V_{\rm P}^{+} - A^{-})$ transition with the trapping of an electron on the a_1 state. The 0.5-eV difference between E_{11} , at $E_v + 0.65$ eV, and the calculated values of the V_P^+ t_2 levels at $E_v + 1.2$ eV, can be explained by the splitting of the t_2 levels during the local reduction of symmetry in the A^{-} pairing.

TABLE II. Calculated positions of the localized states due to the unrelaxed and isotropically charged phosphorus vacancy, $V_{\rm P}$, in InP. The origin of the energies is taken at E_v .

Ref.	Charge state	a_1 level ($E - E_n$	t_2 level in eV)
18	<i>V</i> ⁰	0.28	1.5
19	V^0	0.54	1.32
	V^+	0.38	1.2
	<i>V</i> ²⁺	0.19	1.0

With such a simple hypothesis one can explain the following in a natural way.

The identity of the annealing kinetics of the H_4 and E_{11} levels in their respective hole and electron-free states identified to $(V_P^+ \cdot A^-)$.

The slower annealing of H_4 in its hole-filled state and the faster annealing of E_{11} in its electron-filled state by the increase and decrease of the electrostatic attraction in the $(V_P^{n+} - A^{-})$ pair.

The markedly less efficient generation of the EIID defects in the *n*-type InP than in the *p*-type InP and the necessity to use p^+ -n junctions and not Schottky barriers to observe E_{11} . In the *p*-type material the V_P^{2+} or V_P^{3+} free vacancies associate with the negatively charged ionized acceptors to form complexes, while, in the *n*-type material, the free-phosphorus vacancy V_P , with its t_2 levels close to the conduction band, acts essentially as a donor. This donor character of the free-phosphorus vacancy also explains the unusual increase of the capacitance of p^+ -n junctions subjected to very high irradiation doses, $> 2 \times 10^{16} \text{ e cm}^{-2}$, instead of the usual decrease, since in this case $[V_P]$ becomes comparable or larger than the acceptor concentration in the doping tail of the p^+ -n junction.

Anyway, even if we concede that the proposed $(V_P - A^-)$ pair complex needs to be supported by microscopic observations, such as by EPR experiments, one must try to explain the different annealing behavior of $(H_4 - E_{11})$ in Cd- and Zn-doped *p*-type InP which is shown in Sec. IV to be clearly related to the concomitant generation of H'_4 . The key observations are the following.

In a pure thermal treatment the process is exactly first order with Cd and does not generate H'_4 , while it is approximately first order with Zn and generates H'_4 with a weak efficiency.

Under saturated electron-injection conditions and Zn doping the annealing is no longer first order and the defect transformation $(H_4-E_{11}) \rightarrow H'_4$ has approximately a one-for-one efficiency.

Clearly this is the defect transformation $(H_4 - E_{11}) \rightarrow H'_4$ which is the most efficiently enhanced by the free-carrier recombination and which is responsible for the observed changes in the annealing kinetics. This selective enhancement can be understood by the preferential generation of specific phonon modes during the free-carrier recombination and has also been observed for the stage-I $(H_2 \rightarrow H_4)$ defect transformation.¹⁴ For instance, one can assume that the dissociation of the $(V_{\rm P}-{\rm Zn}^-)$ complex can be achieved by at least two different paths for the moving atomic entity, with two different dominant local phonon modes, and that the one leading to H'_4 is more efficiently excited by the free-carrier recombination. The same hypothesis can also account for the sensitivity of the annealing kinetics to the acceptor species, Cd or Zn, since the dominant phonon mode of the $(V_{\rm P}-A^{-})$ pair depends on the atomic masses and on the bond strengths.

To be more quantitative one can, for instance, assume that in the case of Cd or Zn together with a thermalphonon distribution the complex $C = (V_{\rm P} - A^{-})$ undergoes dissociation and that the released vacancies are either recaptured or annihilated to sinks after rapid diffusion, leading to the following reaction scheme:

$$C \qquad A^{-} + V$$

$$K_{diss}$$

$$K_{c} \qquad \downarrow K_{an}$$
sinks

while in the case of Zn and electron injection, the REDR mechanism, this dissociation runs concurrently with the transformation leading to H'_4 . In the first case the solution of the two coupled equations,

and

$$\frac{d[V]}{dt} = -K_{an}[V] - K_c[A^{-}][V] + K_{diss}[C]$$

 $\frac{d[C]}{dt} = -K_{\text{diss}}[C] + K_c[A^-][V]$

is straightforward using Laplace transforms. As long as recapture is negligible, i.e., as long as $K_c[A^-] < K_{\rm an} + K_{\rm diss}$, the kinetics are exactly first order with $K_{\rm eff} = K_{\rm diss}$. However, the exact solution depends critically on the ratio $K_c / (K_{\rm an} - K_{\rm diss})$, and for low values of this ratio it is well approximated by

$$C(t) \approx C_0 \left[1 + \frac{K_c}{K_{an} - K_d} \right] e^{-K_d t} - C_0 \frac{K_c}{K_{an} - K_d} e^{-K_{an} t}$$

This contribution of two exponential terms can explain the weak difference of the observed pure thermal annealing kinetics of (H_4-E_{11}) in Zn- and Cd-doped samples since the recapture of the released vacancies is probably higher with Zn than with Cd.

Under electron injection the dissociation of [C] runs concurrently with the transformation into H'_4 characterized by an effective frequency K_i , and K_{diss} is simply replaced by $K_d = K_{diss} + K_i$. The resulting kinetics are still the sum of two exponential processes, but in this case they may be of comparable magnitude if the recombination modified constants K'_c , K'_{an} , and K'_d are such that K'_c is comparable to $K'_{an} - K'_d$.

VII. CONCLUSION

The study of the simultaneous annealing out of the two dominant electron-induced-irradiated defects in InP, the hole trap H_4 at $E_v + 0.37$ eV and the electron trap E_{11} at $E_c - 0.72$ eV, made in Cd- or Zn-doped n^+ -p junctions, confirms that they are correlated and strongly supports the idea that they result from the same microscopic defect.

In the case of Zn doping the annealing out of $(H_4 \cdot E_{11})$ generates another localized level H'_4 with a thermally activated hole-capture cross section in the 10^{-24} -cm² range which makes it undetectable in usual deep-level transient spectroscopy experiments.

This hole trap H'_4 is generated by a local-defect transformation, with an approximate 5% efficiency in a pure thermal treatment, and a 0.3 efficiency with additional free-carrier recombination. This local-defect transformation $(H_4 - E_{11}) \rightarrow H'_4$ is responsible for the observed differences of the annealing kinetics in Cd- and Zn-doped samples.

The optical properties of E_{11} and H_4 are drastically different since in the case of E_{11} both electronic transitions from the valence band to E_{11} or from E_{11} to the conduction band are optically induced, while in the case of H_4 the transition to the CB could not be observed.

The full identity of the annealing properties of H_4 and E_{11} under varied conditions is interpreted by assuming that they correspond to two different charge states of the same V(P)- A^- complex. This explains in a natural way the difference in their optical properties and the known low introduction rates of EIID's in *n*-type InP where the unpaired phosphorus vacancies V(P) act essentially as shallow donors.

The local character of the dominant mechanism of the thermal annealing is also demonstrated for the defect transformation $(H_4-E_{11}) \rightarrow H'_4$, and the sensitivity of the exact kinetics to the doping species, as well as to the physical treatment, is assigned to the modified balance between the rate of dissociation of the $V(P)-A^-$ complex and the rate of recapture of the released vacancy.

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- ¹A. Sibille, J. Suski, and M. Gilleron, J. Appl. Phys. **60**, 595 (1986).
- ²A. Sibille, J. Suski, and G. Leroux, Phys. Rev. B **30**, 1119 (1984).
- ³A. Sibille, in Proceedings of the 13th International Conference on the Defects in Semiconductors, Coronado, 1984 [J. Electron. Mater. 14a, 1155 (1984)].
- ⁴T. Bretagnon, G. Bastide, and M. Rouzeyre, in Proceedings of

the 14th International Conference on the Defects in Semiconductors, Paris, 1986, edited by H. J. von Bardeleben (Trans Tech, Switzerland, 1986), p. 1033.

- ⁵A. Sibille and J. Suski, Phys. Rev. B 31, 5551 (1985).
- ⁶J. Suski, A. Sibille, and J. C. Bourgoin, Solid State Commun. **49**, 875 (1984).
- ⁷M. Yamaguchi and K. Ando, J. Appl. Phys. **60**, 935 (1986).
- ⁸M. Yamaguchi, K. Ando, and A. Yamamoto, J. Appl. Phys. **58**, 568 (1985).
- ⁹M. Yamaguchi, Y. Itoh, K. Ando, and A. Yamamoto, Jpn. J.

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Appl. Phys. 25, 1650 (1986).

- ¹⁰K. Ando, M. Yamaguchi, and C. Uemura, Phys. Rev. B 34, 3041 (1986).
- ¹¹B. Massarani and J. C Bourgoin, Phys. Rev. B 34, 2470 (1986).
- ¹²J. L. Benton, M. Lewinson, A. T. Macrander, H. Temkin, and L. C. Kimerling, Appl. Phys. Lett. 45, 566 (1984).
- ¹³A. Sibille, Appl. Phys. Lett. 48, 593 (1986).
- ¹⁴A. Sibille, Phys. Rev. B **35**, 3929 (1987).
- ¹⁵D. Bayaa, G. Bastide, and M. Rouzeyre, Solid State Commun.

51, 359 (1984).

- ¹⁶G. Bastide, D. Bayaa, and M. Rouzeyre, Solid State Commun. 57, 431 (1986).
- ¹⁷A. Chantre, G. Vincent, and D. Bois, Phys. Rev. B 23, 5335 (1983).
- ¹⁸D. N. Talwar and C. S. Ting, Phys. Rev. B 25, 2660 (1982).
- ¹⁹C. Delerue and M. Lanno (private communication).
- ²⁰H. J. von Bardeleben, Solid State Commun. 57, 137 (1986).